Lonten N-channel 600V, 12A Power MOSFET

Description

The Power MOSFET is fabricated using the advanced planer VDMOS technology. The resulting device has low conduction resistance, superior switching performance and high avalance energy.

Features

- Low R_{DS(on)}
- Low gate charge (typ. Q_g = 40.8 nC)
- 100% UIS tested
- RoHS compliant

Applications

- Power factor correction.
- Switched mode power supplies.
- LED driver.



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	600	V
Continuous drain current ($T_c = 25^{\circ}C$)	I _D	12	A
(T _c = 100°C)		7.5	А
Pulsed drain current ¹⁾	I _{DM}	48	A
Gate-Source voltage	V _{GSS}	±30	V
Avalanche energy, single pulse 2)	E _{AS}	605	mJ
Peak diode recovery dv/dt 3)	dv/dt	5	V/ns
Power Dissipation TO-220F ($T_c = 25^{\circ}C$)		42	W
Derate above 25°C		0.34	W/°C
Power Dissipation	P _D		
TO-220\ TO-262\ TO-263 ($T_{C} = 25^{\circ}C$)		150	W
Derate above 25°C		1.2	W/°C
Operating juncition and storage temperature range	T _J , T _{STG}	-55 to +150	°C
Continuous diode forward current	I _S	12	A
Diode pulse current	I _{S,pulse}	48	A

Thermal Characteristics

Deremeter	Value		Unit	
Farameter	Symbol	TO-220F	TO-220\TO-251\TO-252	Unit
Thermal resistance, Junction-to-case	$R_{ extsf{ heta}JC}$	2.98	0.83	°C/W
Thermal resistance, Junction-to-ambient	$R_{\theta J A}$	110	62.5	°C/W

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Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube	Units/Real
LNC12N60	TO-220	LNC12N60	50	
LND12N60	TO-220F	LND12N60	50	
LNE12N60	TO-263	LNE12N60	50	
LNF12N60	TO-262	LNF12N60	50	

Electrical Characteristics T_c = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	V_{GS} =0 V, I _D =0.25 mA	600	-	-	V
Gate threshold voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=0.25$ mA	2	-	4	V
Drain cut-off current	I _{DSS}	V_{DS} =600 V, V_{GS} =0 V,				
		$T_j = 25^{\circ}C$	-	-	1	μA
		T _j = 125°C	-		100	
Gate leakage current, Forward	I _{GSSF}	V_{GS} =30 V, V_{DS} =0 V	-	-	100	nA
Gate leakage current, Reverse	I _{GSSR}	V_{GS} =-30 V, V_{DS} =0 V	-	-	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =6A	-	0.53	0.75	Ω
Dynamic characteristics						
Input capacitance	C _{iss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$	-	1960	-	
Output capacitance	C _{oss}	f = 1 MHz	-	163	-	pF
Reverse transfer capacitance	C _{rss}		-	7.2	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 12 \text{ A}$	-	14.3	-	
Rise time	tr	R_{G} = 10 Ω , V_{GS} =15 V	-	37.6	-	ns
Turn-off delay time	t _{d(off)}		-	65.4	-	
Fall time	t _f		-	14.2	-	
Gate charge characteristics						
Gate to source charge	Q _{gs}	V _{DD} =480 V, I _D =12 A,	-	11.0	-	
Gate to drain charge	Q_{gd}	V_{GS} =0 to 10 V	-	15.6	-	nC
Gate charge total	Qg		-	40.8	-	
Gate plateau voltage	V _{plateau}		-	5	-	V
Reverse diode characteristics						
Diode forward voltage	V_{SD}	V _{GS} =0 V, I _F =12 A	-	-	1.5	V
Reverse recovery time	trr	V _R =300 V, I _F =12 A,	-	387.2	-	ns
Reverse recovery charge	Q _{rr}	dI _F /dt=100 A/µs	-	3.87	-	μC
Peak reverse recovery current	Irrm		-	20.3	-	А

Notes:

1. Pulse width limited by maximum junction temperature.

2. L=10mH, I_{AS} = 11A, Starting T_{j} = 25°C.

3. I_{SD} = 12A, di/dt \leq 100A/us, $V_{DD}\leq$ BV_{DS}, Starting T_j= 25°C.



Figure 2. Transfer Characteristics

Electrical Characteristics Diagrams

Figure 1. Typical Output Characteristics



Figure 3. On-Resistance Variation vs. Drain Current







V_{GS} ,Gate-source voltage (V)









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 $V_{\rm DS}$,Drain-Source Voltage (V)









Figure 12. Power Dissipation vs. Temperature



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Figure 13. Continuous Drain Current vs. Temperature





Gate Charge Test Circuit & Waveform









Unclamped Inductive Switching Test Circuit & Waveforms







Mechanical Dimensions for TO-220





	UNIT: mm			
SYMBOL	MIN	NOM	MAX	
А	4		4.8	
В	1.2		1.4	
B1	1		1.4	
b1	0.75		0.95	
с	0.4		0.55	
D	15		16.5	
D1	5.9		6.9	
E	9.9		10.7	
е	2.44	2.54	2.64	
F	1.1		1.4	
L	12.5		14.5	
L1	3	3.5	4	
ΦР	3.7	3.8	3.9	
Q	2.5		3	
Q1	2		2.9	
Y	8.02	8.12	8.22	

TO-220 Part Marking Information





Mechanical Dimensions for TO-220F



		UNIT: mm		
SYMBOL	MIN	NOM	MAX	
А	4.5		4.9	
A1	2.3		2.9	
b	0.65		0.9	
b1	1.1		1.7	
b2	1.2		1.4	
с	0.35		0.65	
D	14.5		16.5	
D1	6.1		6.9	
E	9.6		10.3	
E1	6.5	7	7.5	
е	2.44	2.54	2.64	
L	12.5		14.3	
L1	9.45		10.05	
L2	15		16	
L3	3.2		4.4	
ΦΡ	3		3.3	
Q	2.5		2.9	

TO-220F Part Marking Information





Mechanical Dimensions for TO-262





	UNIT: mm			
SYMBOL	MIN	NOM	MAX	
А	4.42		4.72	
A1	2.40		2.80	
b	0.76		0.86	
b1	1.22		1.40	
с	0.33		0.43	
c2	1.22		1.35	
D	8.99		9.29	
е	2.44	2.54	2.64	
e1	4.98		5.18	
E	9.95		10.25	
L	12.50		13.60	
L1	3.30	3.50	3.80	
L2	1.22		1.40	
Y	8.02	8.12	8.22	

TO-262 Part Marking Information





Mechanical Dimensions for TO-263





	UNIT: mm		
SYMBOL	MIN	NOM	MAX
А	4.42		4.72
В	1.22		1.4
b	0.76		0.86
b1	1.22		1.4
b2	0.33		0.43
С	1.22		1.35
D	9.95		10.25
E	8.99		9.29
e1	2.44	2.54	2.64
e2	4.98		5.18
L1	14.7	15.1	15.5
L2	2	2.3	2.6
L3	1.5		2
К	-0.1		0.1
Y	8.02	8.12	8.22

TO-263 Part Marking Information



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